

Description

The SI1012X-T1-GE3 uses advanced trench technology to provide excellent $R_{DS(ON)}$, low gate charge and operation with gate voltages as low as 2.5V. This device is suitable for use as a Battery protection or in other Switching application.

General Features

$$\begin{split} V_{DS} &= 20V \ \ I_D = 0.8A \\ R_{DS(ON)} &< 250 \ \text{m}\Omega @ \ V_{GS} = 4.5V \\ R_{DS(ON)} &< 360 \ \text{m}\Omega @ \ V_{GS} = 2.5V \end{split}$$

Application

Battery protection Load switch Uninterruptible power supply

Package Marking and Ordering Information

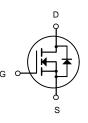
Product ID	Pack	Brand	Qty(PCS)
SI1012X-T1-GE3	SOT-523	HXY MOSFET	3000

Absolute Maximum Ratings (T_A=25[°]C unless otherwise noted)

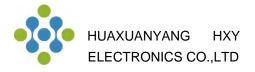
Symbol	Parameter	Limit	Unit	
VDS	Drain-Source Voltage	20	V	
Vgs	Gate-Source Voltage	±8	V	
I _D	Drain Current-Continuous	0.8	А	
P _D	Maximum Power Dissipation	0.15	W	
TJ,TSTG	Operating Junction and Storage Temperature Range	-55 To 150	°C	
Reja	Thermal Resistance, Junction-to-Ambient (Note 2)	850	°C/W	







N-Channel MOSFET



Electrical Characteristics (TJ=25 °C, unless otherwise noted)

Parameter	Symbol	Test conditions	Min	Тур	Max	Unit
STATIC CHARACTERISTICE						
Drain-source breakdown voltage	V _{(BR)DSS}	V _{GS} = 0V, I _D =250µA	20			V
Zero gate voltage drain current	I _{DSS}	V _{DS} =20V,V _{GS} = 0V			1	μA
Gate-body leakage current	I _{GSS}	$V_{GS} = \pm 8V, V_{DS} = 0V$			±10	μA
Gate threshold voltage (note2)	V _{GS(th)}	V _{DS} =V _{GS} , I _D =250µA	0.5	0.7	1.0	V
	R _{DS(on)}	V _{GS} =4.5V, I _D =0.5A		0.18	0.25	Ω
Drain-source on-resistance (note2)		V _{GS} =2.5V, I _D =0.5A		0.27	0.36	Ω
Maximum Continuous Drain to Source Diode Forward Current	ls				0.8	А
Maximum Pulsed Drain to Source Diode Forward Current	I _{SM}				1.2	A
Diode forward voltage	V _{SD}	I _S =0.5A, V _{GS} =0V			1.2	V
DYNAMIC CHARACTERISTICS (note4)						
Input capacitance	Ciss			50		pF
Output capacitance	Coss	V _{DS} =16V,V _{GS} =0V, f =1MHz		7		pF
Reverse transfer capacitance	Crss			4.5		pF
SWITCHING CHARACTERISTICS (no	te4)		·			
Turn-on delay time (note3)	t _{d(on)}			2		nS
Turn-on rise time (note3)	tr			32		nS
Turn-off delay time (note3)	t _{d(off)}	V_{GS} =4.5V, V_{DS} =10V, R_L =10 Ω		47		nS
Turn-off fall time (note3)	t _f			22		nS

Notes:

1. Surface mounted on FR4 board using the minimum recommended pad size.

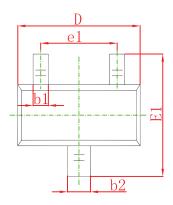
2. Pulse Test : Pulse Width=300µs, Duty Cycle=2%.

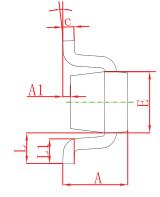
3. Switching characteristics are independent of operating junction temperatures.

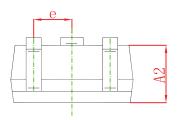
4. Guaranteed by design, not subject to producting.



SOT-523 Package Information

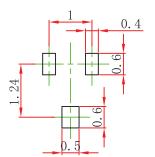






Symbol	Dimensions	In Millimeters	Dimensions In Inches		
	Min.	Max.	Min.	Max.	
А	0.700	0.900	0.028	0.035	
A1	0.000	0.100	0.000	0.004	
A2	0.700	0.800	0.028	0.031	
b1	0.150	0.250	0.006	0.010	
b2	0.250	0.350	0.010	0.014	
С	0.100	0.200	0.004	0.008	
D	1.500	1.700	0.059	0.067	
E	0.700	0.900	0.028	0.035	
E1	1.450	1.750	0.057	0.069	
e	0.500 TYP.		0.020 TYP.		
e1	0.900	1.100	0.035	0.043	
L	0.400 REF.		0.016 REF.		
L1	0.260	0.460	0.010	0.018	
θ	0°	8°	0°	8°	

SOT-523 Suggested Pad Layout



Note:

1.Controlling dimension:in millimeters.

2.General tolerance:±0.05mm.

3. The pad layout is for reference purposes only.



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